COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

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<th>PCB VIEWED FROM TOP SIDE</th>
<th>BOARD #: DRV10983REF</th>
<th>REV: E1</th>
<th>SUN REV: Not In VersionControl</th>
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<tr>
<td>IGNORE: Top Overlay</td>
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<td>PLOT NAME = Top Assembly Drawing</td>
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**COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.**

ASSEMBLY VARIANT: 001

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PLOT NAME = Bottom Assembly Drawing

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